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CONFIRMATION NO. 7641

SERIAL NUMBER 10/065,568	FILING DATE 10/31/2002 RULE	CLASS 438	GROUP ART UNIT 2824	ATTORNEY DOCKET NO. NAUP0482USA
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APPLICANTS

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** CONTINUING DATA ***** *None
MSC*

** FOREIGN APPLICATIONS ***** *None
MSC*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 11/07/2002

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY	SHEETS DRAWING	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after <i>Allowance</i>	TAIWAN	8	10	2
Verified and Acknowledged	<i>MSC</i>	Examiner's Signature	Initials		

ADDRESS

027765
 NAIPO (NORTH AMERICA INTERNATIONAL PATENT OFFICE)
 P.O. BOX 506
 MERRIFIELD , VA
 22116

TITLE

Solder bump structure and laser repair process for memory device

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